



T-52-07

54BCT/74BCT2244

Octal Buffer/Line Driver

with 25Ω Series Resistors in the Outputs

General Description

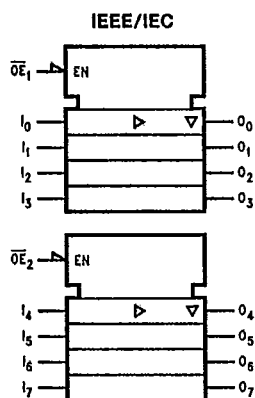
The 'BCT2244 is an octal buffer and line driver designed to drive the capacitive inputs of MOS memory drivers, address drivers, clock drivers, and bus-oriented transmitters/receivers.

The 25Ω series resistors in the outputs reduce ringing and eliminate the need for external resistors.

Features

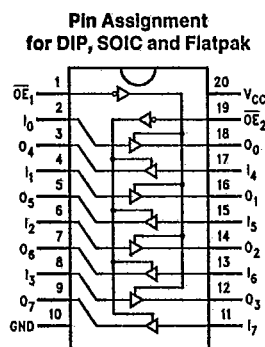
- 25Ω series resistors in outputs eliminate the need for external resistors
- TRI-STATE® outputs drive bus lines or buffer memory address registers
- Low I_{CCZ} through BiCMOS techniques
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Guaranteed 4000V minimum ESD protection
- Guaranteed latchup protection
- Nondestructive hot insertion capability
- High impedance in power down (I_{ZZ} and V_{IO})

Logic Symbol



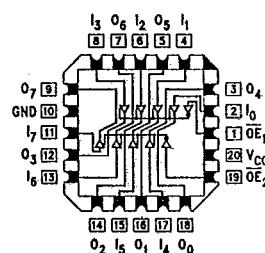
TL/F/10896-1

Connection Diagrams



TL/F/10896-2

Pin Assignment for LCC



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54BCT/74BCT2244 Octal Buffer/Line Driver with 25Ω Series Resistors in the Outputs

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	Output Enable Input (Active Low)
I_0-I_7	Inputs
O_0-O_7	Outputs

1 9000-2710

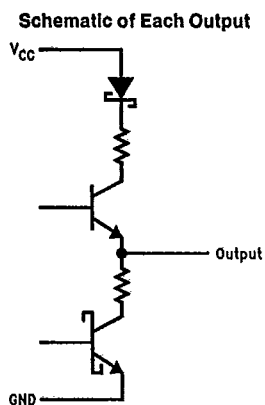
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Truth Table

$\overline{OE}_1$	I_{0-3}	O_{0-3}	$\overline{OE}_2$	I_{4-7}	O_{4-7}
H	X	Z	H	X	Z
L	H	H	L	H	H
L	L	L	L	L	L

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H = HIGH Voltage Level
 L = LOW Voltage Level
 X = Immaterial
 Z = High Impedance



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	
Ceramic	-55°C to +175°C
Plastic	-55°C to +150°C
V _{CC} Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

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Voltage Applied to Any Output in the Disable or Power-Off State	-0.5V to +5.5V
in the High State	-0.5V to V _{CC}
Current Applied to Output in LOW State (Max)	twice the rated I _{OL} (mA)
ESD Last Passing Voltage (Min)	4000V
DC Latchup Source Current	500 mA
Over Voltage Latchup	V _{CC} + 4.5V

Recommended Operating Conditions

Free Air Ambient Temperature	
Military	-55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

DC Electrical Characteristics

Symbol	Parameter	54BCT/74BCT			Units	V _{CC}	Conditions
		Min	Typ	Max			
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			-1.2	V	Min	I _{IN} = -18 mA
V _{OH}	Output HIGH Voltage	54BCT/74BCT	2.4		V	Min	I _{OH} = -3 mA I _{OH} = -12 mA I _{OH} = -15 mA
V _{OL}	Output LOW Voltage	54BCT/74BCT		0.55	V	Min	I _{OL} = 3 mA I _{OL} = 12 mA I _{OL} = 15 mA
I _{IH}	Input HIGH Current			5	μA	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test			7	μA	Max	V _{IN} = 7.0V
I _{IL}	Input LOW Current			-250	μA	Max	V _{IN} = 0.5V
I _{OS}	Output Short-Circuit Current	-100		-225	mA	Max	V _{OUT} = 0V
I _{OZH}	Output Leakage Current			20	μA	Max	V _{OUT} = 2.7V
I _{OZL}	Output Leakage Current			-20	μA	Max	V _{OUT} = 0.5V
I _{CEX}	Output HIGH Leakage Current			50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{ZZ}	Bus Drainage Test			100	μA	0.0	V _{OUT} = 5.25V
I _{CCH}	Power Supply Current		23	34	mA	Max	V _O = HIGH
I _{CCL}	Power Supply Current		40	60	mA	Max	V _O = LOW
I _{CCZ}	Power Supply Current		5.6	10	mA	Max	V _O = HIGH Z

AC Electrical Characteristics

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Symbol	Parameter	54BCT/74BCT			54BCT		74BCT		Units
		$T_A = +25^{\circ}\text{C}$ $V_{CC} = +5.0\text{V}$ $C_L = 50\text{ pF}$			$T_A = \text{Mil}$ $V_{CC} = \text{Mil}$ $C_L = 50\text{ pF}$		$T_A = \text{Comm}$ $V_{CC} = \text{Comm}$ $C_L = 50\text{ pF}$		
		Min	Typ	Max	Min	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay Data to Output	0.5 1.6	3 3.7	4.4 6.3			0.5 1.6	4.9 6.7	ns
t_{PZH} t_{PZL}	Output Enable Time	2.4 3.9	6.1 7.1	7.7 9.4			2.4 3.9	8.7 10.4	ns
t_{PHZ} t_{PLZ}	Output Disable Time	1.7 1.7	4 6	6.9 8.3			1.7 1.7	7.8 9.8	ns
t_{OSHL} (Note 1)	Pin to Pin Skew HL Data to Output			1.8				2.8	ns
t_{OSLH} (Note 1)	Pin to Pin Skew HL Data to Output			1.0				1.2	ns
t_{OST} (Note 1)	Pin to Pin Skew LH/HL Data to Output			2.9				3.3	ns
t_{PV} (Note 2)	Device to Device Skew LH/HL Data to Output			3.5				3.9	ns

Note 1: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH to LOW (t_{OSHL}), LOW to HIGH (t_{OSLH}), or any combination switching LOW to HIGH and/or HIGH to LOW (t_{OST}). This specification is guaranteed but not tested.

Note 2: Propagation delay variation for a given set of conditions (i.e., temperature and V_{CC} , from device to device. This specification is guaranteed but not tested.

Extended AC Electrical Characteristics—Preliminary

Symbol	Parameter	74BCT		54BCT		74BCT		54BCT		Units
		T _A = Com V _{CC} = Com C _L = 50 pF 8 Outputs Switching (Note 3)		T _A = Mil V _{CC} = Mil C _L = 50 pF 8 Outputs Switching (Note 3)		T _A = Com V _{CC} = Com C _L = 250 pF (Note 4)		T _A = Mil V _{CC} = Mil C _L = 250 pF (Note 4)		
		Min	Typ	Max	Min	Max	Min	Max	Min	
t _{PLH} t _{PHL}	Propagation Delay Data to Output	2.0 3.0	5.4 7.2			3.0 3.0	7.0 9.5			ns
t _{OSHL} (Note 1)	Pin to Pin Skew HL Data to Output									ns
t _{OSLH} (Note 1)	Pin to Pin Skew LH Data to Output									ns
t _{OST} (Note 1)	Pin to Pin Skew LH/HL Data to Output									ns
t _{pv} (Note 2)	Device to Device Skew LH/HL Data to Output									ns

Note 1: Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH to LOW (t_{OSHL}), LOW to HIGH (t_{OSLH}), or any combination switching LOW to HIGH and/or HIGH to LOW (t_{OST}).

Note 2: Propagation delay variation for a given set of conditions (i.e., temperature and V_{CC}) from device to device.

Note 3: This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all low-to-high, high-to-low, etc.).

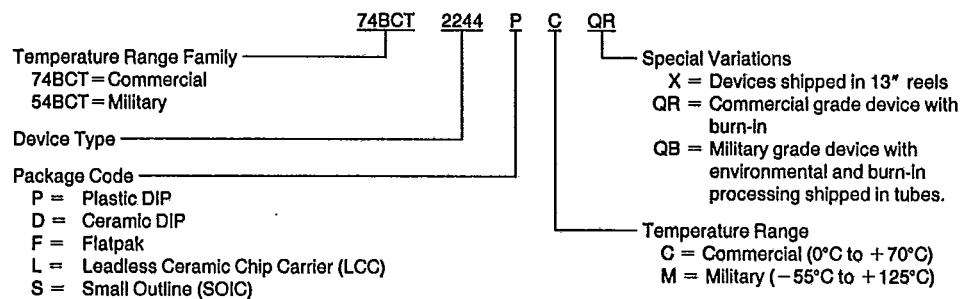
Note 4: This specification is guaranteed but not tested. The limits represent propagation delays with 250 pF load capacitors in place of the 50 pF load capacitors in the standard AC load. This specification pertains to single output switching only.

Capacitance**T-52-07**

Symbol	Parameter	Typ	Units	Conditions
C _{IN}	Input Capacitance	6	pF	V _{CC} = 5.0V
C _{OUT}	Output Pin Capacitance	11	pF	V _{CC} = 5.0V

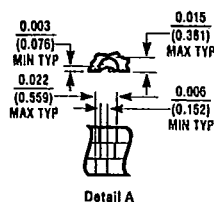
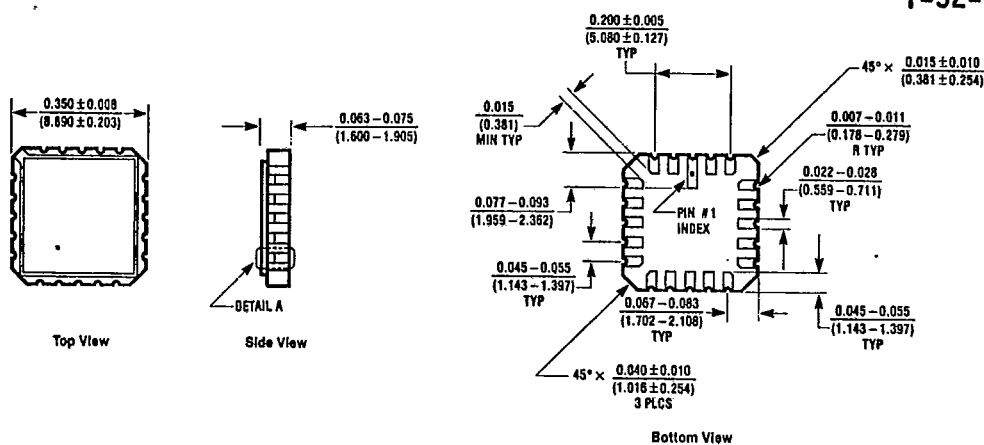
Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



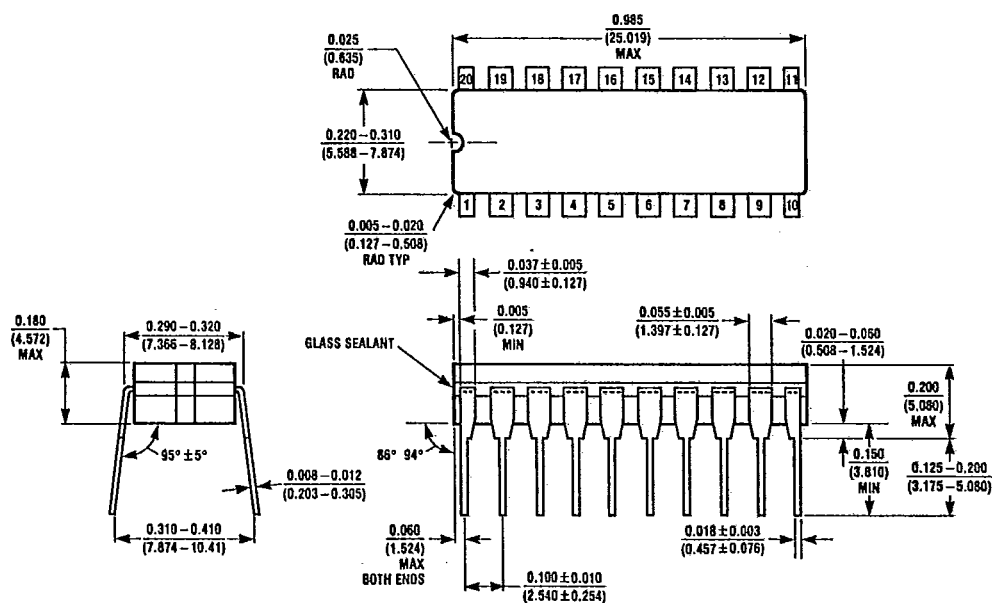
Physical Dimensions inches (millimeters)

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20-Terminal Ceramic Leadless Chip Carrier (L)
NS Package Number E20A

E20A (REV D)

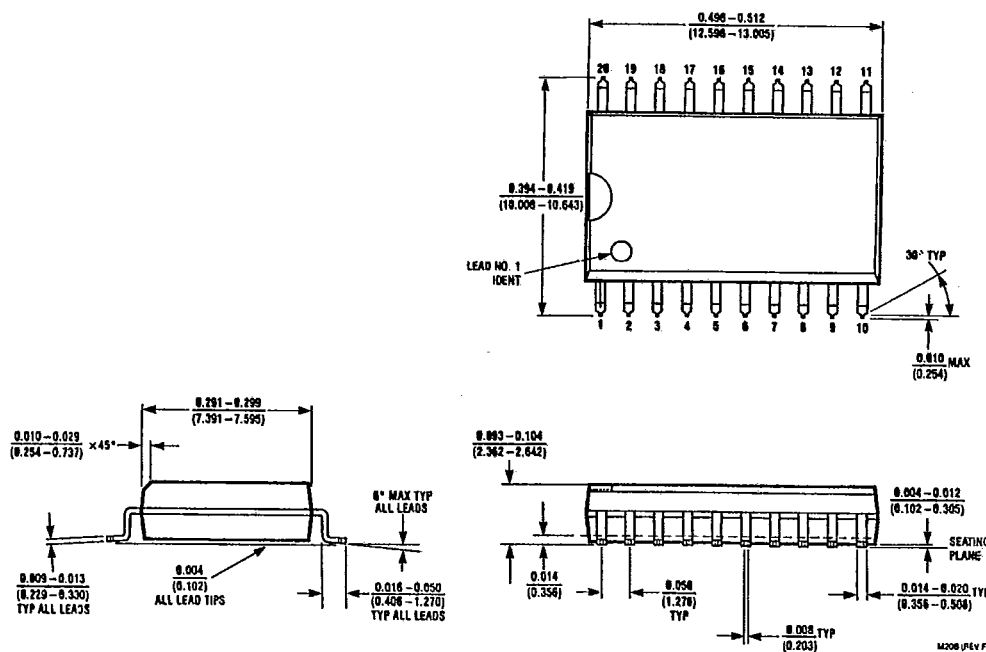


20-Lead Ceramic Dual-In-Line Package (D)
NS Package Number J20A

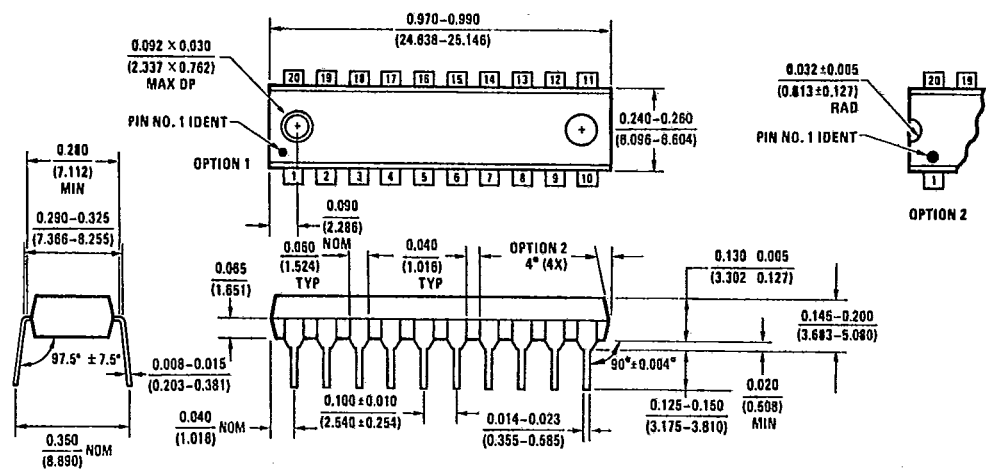
J20A (REV M)

Physical Dimensions inches (millimeters) (Continued)

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20-Lead Small Outline Integrated Circuit (S)
NS Package Number M20B

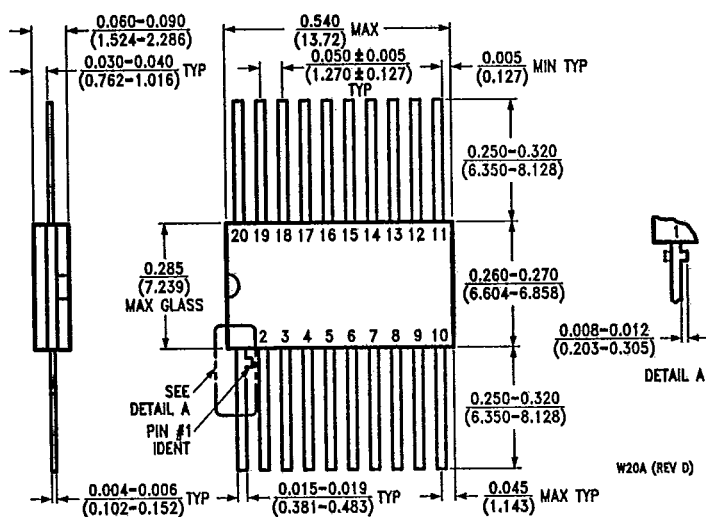


20-Lead Plastic Dual-In-Line Package (P)
NS Package Number N20B

Physical Dimensions inches (millimeters) (Continued)

LIT #: 114628

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20-Lead Ceramic Flatpak (F)
NS Package Number W20A

LIFE SUPPORT POLICY

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